

MEMS audio sensor omnidirectional digital microphone

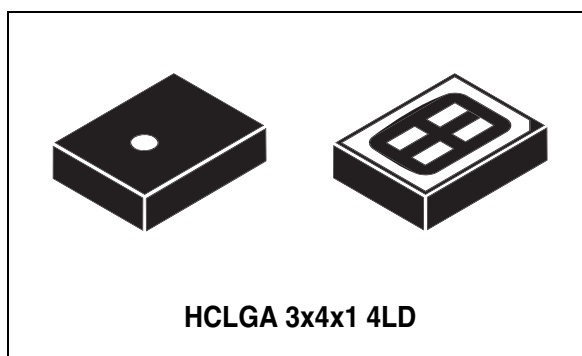
Datasheet – production data

Features

- Single supply voltage
- Low power consumption
- 120 dB SPL acoustic overload point
- 63 dB signal-to-noise ratio
- Omnidirectional sensitivity
- -26 dBFS sensitivity
- PDM output
- HCLGA package
 - Top-port design
 - SMD-compliant
 - EMI-shielded
 - ECOPACK®, RoHS, and “Green” compliant

Applications

- Mobile terminals
- Laptop and notebook computers
- Portable media players
- VoIP
- Speech recognition
- A/V eLearning devices
- Gaming and virtual reality input devices
- Digital still and video cameras
- Antitheft systems



Description

The MP34DT01 is an ultra-compact, low-power, omnidirectional, digital MEMS microphone built with a capacitive sensing element and an IC interface.

The sensing element, capable of detecting acoustic waves, is manufactured using a specialized silicon micromachining process dedicated to produce audio sensors.

The IC interface is manufactured using a CMOS process that allows designing a dedicated circuit able to provide a digital signal externally in PDM format.

The MP34DT01 has an acoustic overload point of 120 dB SPL with a 63 dB signal-to-noise ratio and -26 dBFS sensitivity.

The MP34DT01 is available in a top-port, SMD-compliant, EMI-shielded package and is guaranteed to operate over an extended temperature range from -40 °C to +85 °C.

Table 1. Device summary

Part number	Temperature range [°C]	Package	Packing
MP34DT01	-40 to +85	HCLGA (3 x 4 x 1) mm 4LD	Tray
MP34DT01TR	-40 to +85	HCLGA (3 x 4 x 1) mm 4LD	Tape and reel

Contents

1	Pin description	5
2	Acoustic and electrical specifications	6
	2.1 Acoustic and electrical characteristics	6
	2.2 Timing characteristics	7
	2.3 Frequency response	8
3	Sensing element	9
4	Absolute maximum ratings	10
5	Functionality	11
	5.1 L/R channel selection	11
6	Package mechanical data	12
7	Revision history	15

List of tables

Table 1.	Device summary	1
Table 2.	Pin description	5
Table 3.	Acoustic and electrical characteristics	6
Table 4.	Distortion specifications	6
Table 5.	Timing characteristics	7
Table 6.	Frequency response mask for digital microphones	8
Table 7.	Absolute maximum ratings	10
Table 8.	L/R channel selection	11
Table 9.	Recommended soldering profile limits	12
Table 10.	HCLGA 3 mm x 4 mm x 1 mm 4-lead package dimensions	13
Table 11.	Document revision history	15

List of figures

Figure 1.	Pin connections	5
Figure 2.	Timing waveforms	7
Figure 3.	Typical frequency response normalized at 1 kHz	8
Figure 4.	Recommended soldering profile limits	12
Figure 5.	HCLGA 3 mm x 4 mm x 1 mm 4-lead package outline	13
Figure 6.	Land pattern	14

1 Pin description

Figure 1. Pin connections

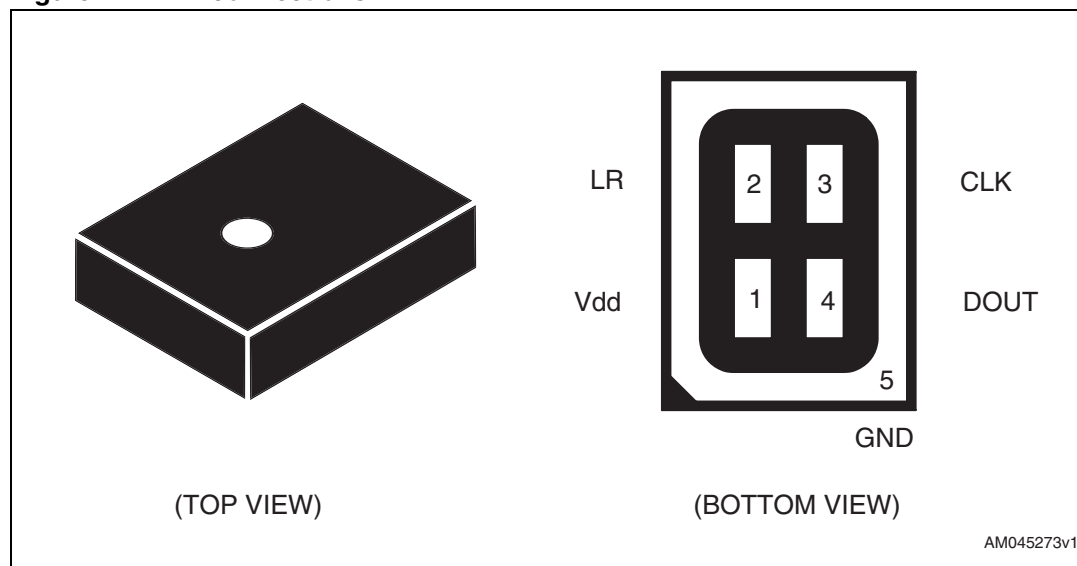


Table 2. Pin description

Pin #	Pin name	Function
1	Vdd	Power supply
2	LR	Left/Right channel selection
3	CLK	Synchronization input clock
4	DOUT	Left/Right PDM data output
5 (ground ring)	GND	0 V supply

2 Acoustic and electrical specifications

2.1 Acoustic and electrical characteristics

The values listed in the table below are specified for Vdd = 1.8 V, Clock = 2.4 MHz, T = 25 °C, unless otherwise noted.

Table 3. Acoustic and electrical characteristics

Symbol	Parameter	Test condition	Min.	Typ. ⁽¹⁾	Max.	Unit
Vdd	Supply voltage		1.64	1.8	3.6	V
Idd	Current consumption in normal mode	Mean value		0.6		mA
IddPdn	Current consumption in power-down mode ⁽²⁾			20		μA
Sc	Short-circuit current		1		10	mA
AOP	Acoustic overload point			120		dB SPL
So	Sensitivity		-29	-26	-23	dBFS
SNR	Signal-to-noise ratio	A-weighted at 1 kHz, 1 Pa		63		dB
PSR	Power supply rejection	Guaranteed by design		-70		dBFS
Clock	Input clock frequency ⁽³⁾		1	2.4	3.25	MHz
Ton	Turn-on time ⁽⁴⁾	Guaranteed by design			10	ms
Top	Operating temperature range		-40		+85	°C
V _{IOL}	Low level logic input/output voltage	I _{out} = 1 mA	-0.3		0.35xVdd	V
V _{IOH}	High level logic input/output voltage	I _{out} = 1 mA	0.65xVdd		Vdd+0.3	V

1. Typical specifications are not guaranteed.
2. Input clock in static mode.
3. Duty cycle: min = 40% max = 60%.
4. Time from the first clock edge to valid output data.

Table 4. Distortion specifications

Parameter	Test condition	Value
Distortion	100 dB SPL (50 Hz - 4 kHz)	< 1% THD + N
Distortion	115 dB SPL (1 kHz)	< 5% THD + N

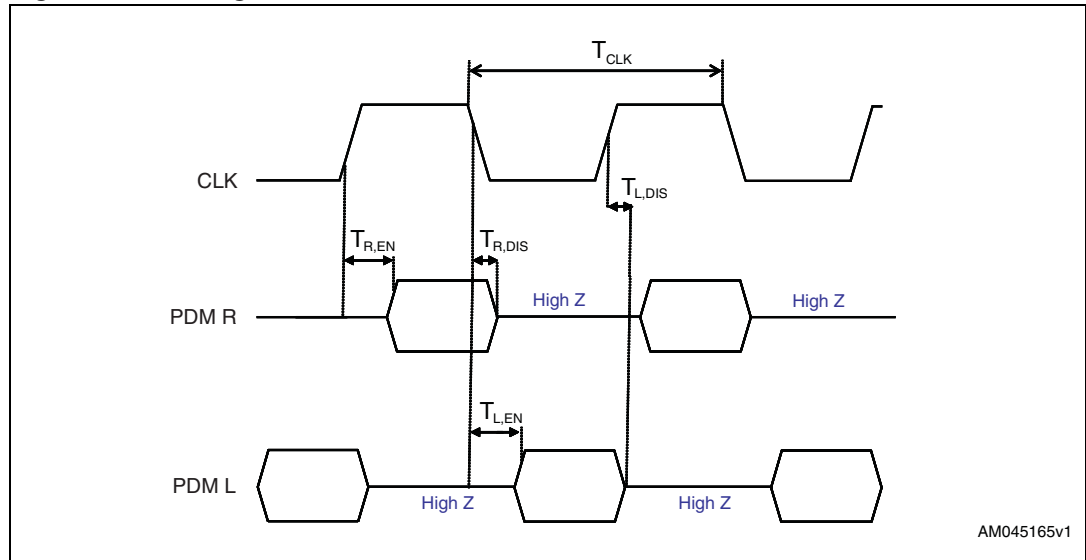
2.2 Timing characteristics

Table 5. Timing characteristics

Parameter	Description	Min	Max	Unit
f_{CLK}	Clock frequency for normal mode	1	3.25	MHz
f_{PD}	Clock frequency for power-down mode		0.23	MHz
T_{CLK}	Clock period for normal mode	308	1000	ns
$T_{R,EN}$	Data enabled on DATA line, L/R pin = 1	18 ⁽¹⁾		ns
$T_{R,DIS}$	Data disabled on DATA line, L/R pin = 1		16 ⁽¹⁾	ns
$T_{L,EN}$	Data enabled on DATA line, L/R pin = 0	18 ⁽¹⁾		ns
$T_{L,DIS}$	Data disabled on DATA line, L/R pin = 0		16 ⁽¹⁾	ns

1. From design simulations

Figure 2. Timing waveforms



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2.3 Frequency response

Figure 3. Typical frequency response normalized at 1 kHz

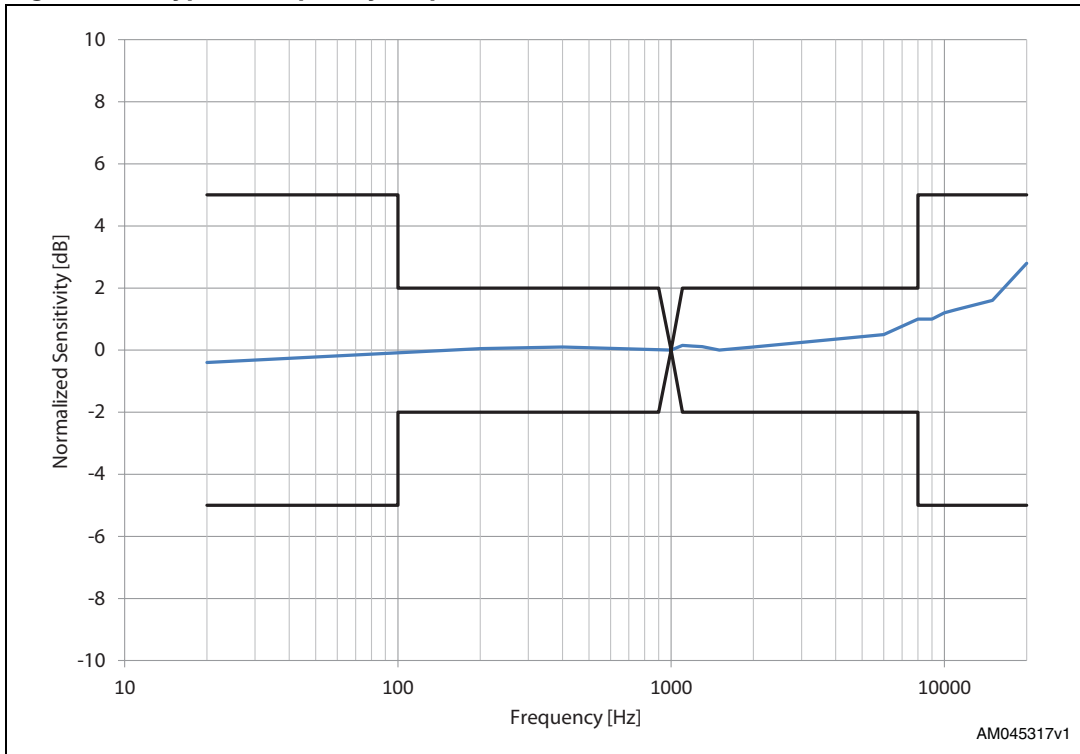


Table 6. Frequency response mask for digital microphones

Frequency / Hz ⁽¹⁾	Lower limit	Upper limit	Unit
20...100	-5	+5	dBr 1kHz
100...8000	-2	+2	dBr 1kHz
8000...20000	-5	+5	dBr 1kHz

1. At T = 20 °C and acoustic stimulus = 1 Pa (94 dB SPL)

3 Sensing element

The sensing element shall mean the acoustic sensor consisting of a conductive movable plate and a fixed plate placed in a tiny silicon chip. This sensor transduces the sound pressure into the changes of coupled capacity between those two plates.


Omron Corporation supplies this element for STMicroelectronics.


4 Absolute maximum ratings

Stresses above those listed as “absolute maximum ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device under these conditions is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

Table 7. Absolute maximum ratings

Symbol	Ratings	Maximum value	Unit
Vdd	Supply voltage	-0.3 to 6	V
Vin	Input voltage on any control pin	-0.3 to Vdd +0.3	V
T _{STG}	Storage temperature range	-40 to +125	°C
ESD	Electrostatic discharge protection	2 (HBM)	kV

 This device is sensitive to mechanical shock, improper handling can cause permanent damage to the part.

 This device is ESD-sensitive, improper handling can cause permanent damage to the part.

5 Functionality

5.1 L/R channel selection

The L/R digital pad lets the user select the DOUT signal pattern as shown in [Table 8](#). The L/R pin must be connected to Vdd or GND.

Table 8. L/R channel selection

L/R	CLK low	CLK high
GND	Data valid	High impedance
Vdd	High impedance	Data valid

6 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Soldering information

The HCLGA 3x4 4LD package is also compliant with the RoHS and “Green” standards and is qualified for soldering heat resistance according to JEDEC J-STD-020.

Landing pattern and soldering recommendations are available at www.st.com.

Figure 4. Recommended soldering profile limits

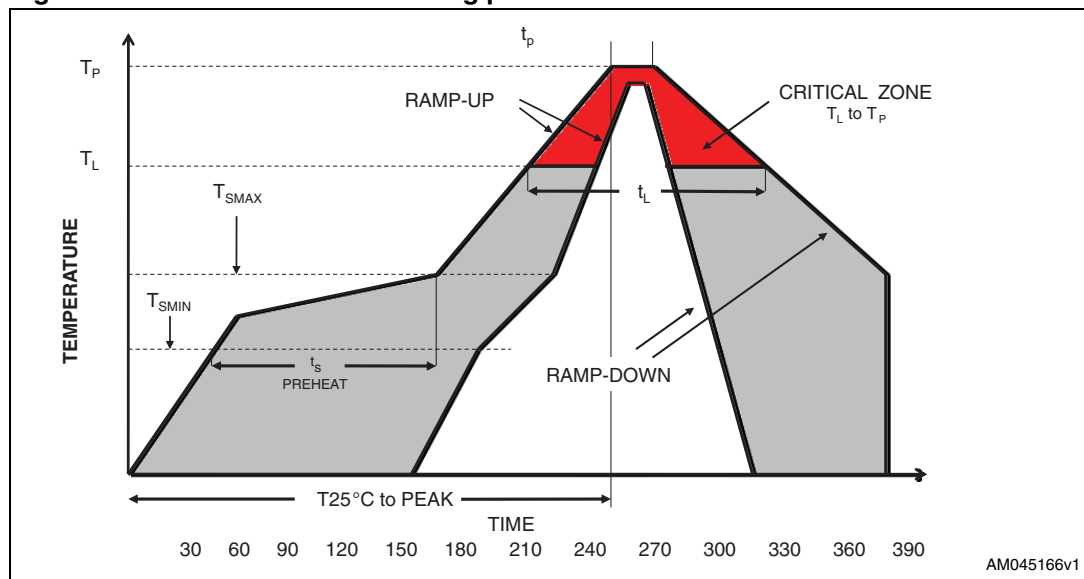


Table 9. Recommended soldering profile limits

Description	Parameter	Pb free
Average ramp rate	T_L to T_P	3 °C/sec max
Preheat		
Minimum temperature	T_{SMIN}	150 °C
Maximum temperature	T_{SMAX}	200 °C
Time (T_{SMIN} to T_{SMAX})	t_s	60 sec to 120 sec
Ramp-up rate	T_{SMAX} to T_L	
Time maintained above liquidous temperature	t_L	60 sec to 150 sec
Liquidous temperature	T_L	217 °C
Peak temperature	T_P	260 °C max
Time within 5 °C of actual peak temperature		20 sec to 40 sec
Ramp-down rate		6 °C/sec max
Time 25 °C ($t_{25\text{ °C}}$) to peak temperature		8 minutes max

Figure 5. HCLGA 3 mm x 4 mm x 1 mm 4-lead package outline

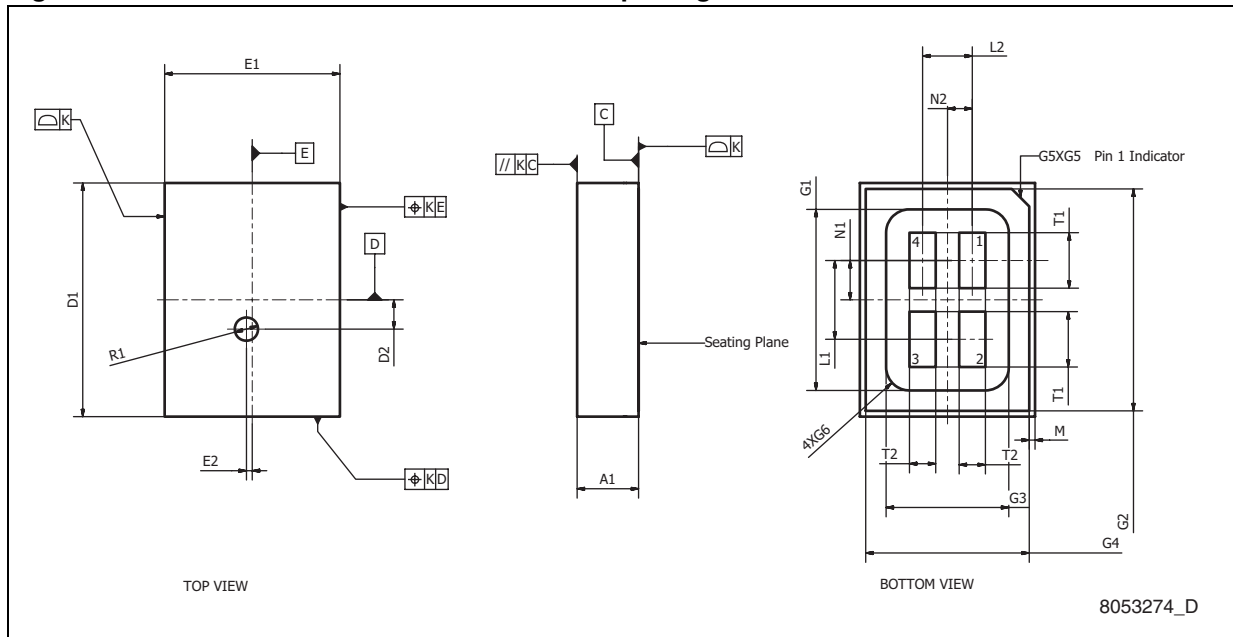
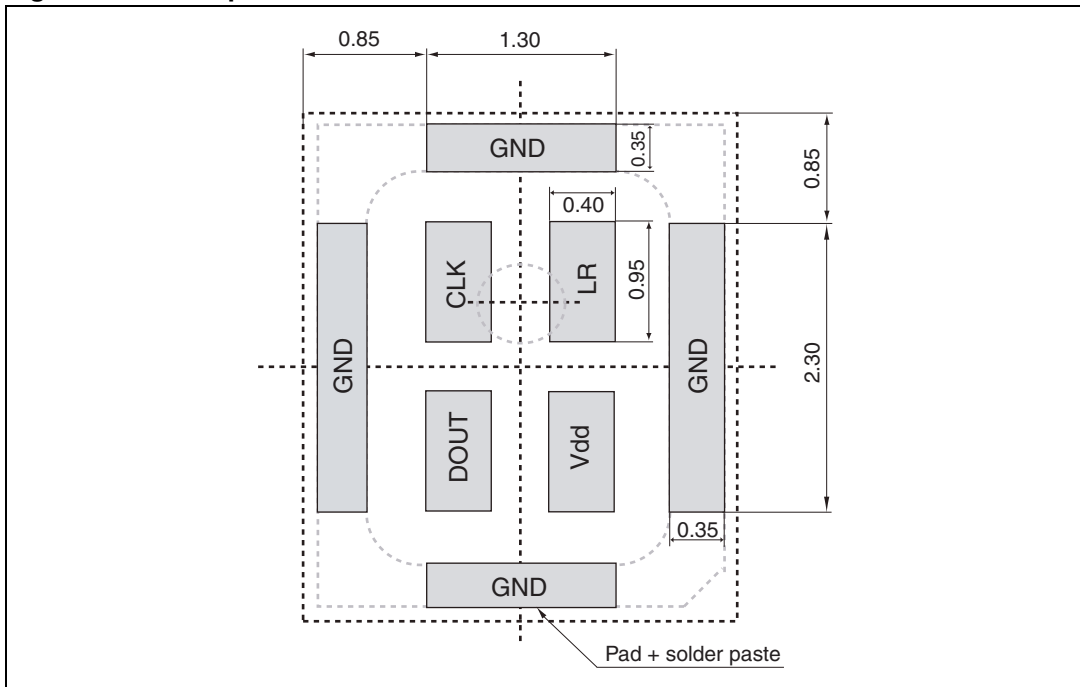


Table 10. HCLGA 3 mm x 4 mm x 1 mm 4-lead package dimensions

Symbol	mm		
	Min	Typ	Max
A1	0.900	1.000	1.100
D1	3.900	4.000	4.100
D2	0.300	0.500	0.700
R1	0.300	0.400	0.500
E1	2.900	3.000	3.100
E2		0.000	±0.200
L1	1.300	1.350	1.400
L2	0.800	0.850	0.900
N1	0.625	0.675	0.725
N2	0.375	0.425	0.475
T1	0.900	0.950	1.000
T2	0.350	0.400	0.450
G1	3.050	3.100	3.150
G2	3.750	3.800	3.850
G3	2.050	2.100	2.150
G4	2.750	2.800	2.850
G5	0.250	0.300	0.350
G6		0.400	
M		0.100	
K		0.050	

Figure 6. Land pattern



7 Revision history

Table 11. Document revision history

Date	Revision	Changes
06-Oct-2011	1	Initial release
18-Nov-2011	2	Removed "stereo" from title, <i>Features</i> , and <i>Description</i>
29-Nov-2011	3	Updated <i>Features</i> and <i>Description</i>
04-Jan-2012	4	Updated <i>Figure 3: Typical frequency response normalized at 1 kHz</i> Added So limits to <i>Table 3: Acoustic and electrical characteristics</i> Minor textual updates
23-Mar-2012	5	Updated <i>Figure 5: HCLGA 3 mm x 4 mm x 1 mm 4-lead package outline</i> Pin 1 indicator removed from top view of package on page 1 and <i>Figure 1: Pin connections</i> Updated <i>Table 10: HCLGA 3 mm x 4 mm x 1 mm 4-lead package dimensions</i>
06-Apr-2012	6	Updated maximum supply voltage in <i>Table 3: Acoustic and electrical characteristics</i>
07-May-2012	7	Added V_{IOL} , V_{IOH} to <i>Table 3: Acoustic and electrical characteristics</i>
18-May-2012	8	Updated <i>Table 5: Timing characteristics</i>
05-Jul-2012	9	Added <i>Section 3: Sensing element</i> Added <i>Figure 6: Land pattern</i> Updated temperature range to -40 to +85 °C throughout datasheet

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